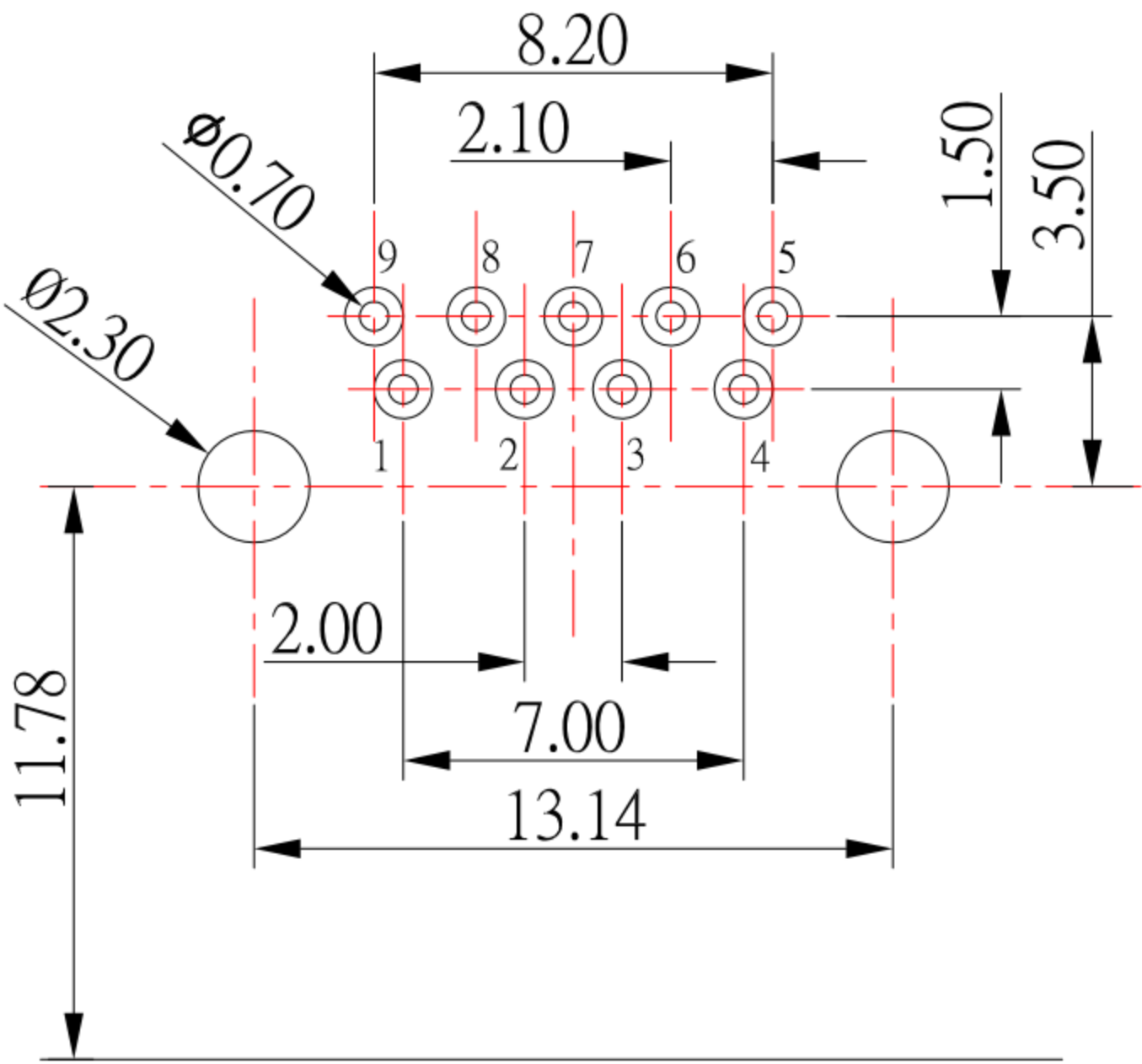
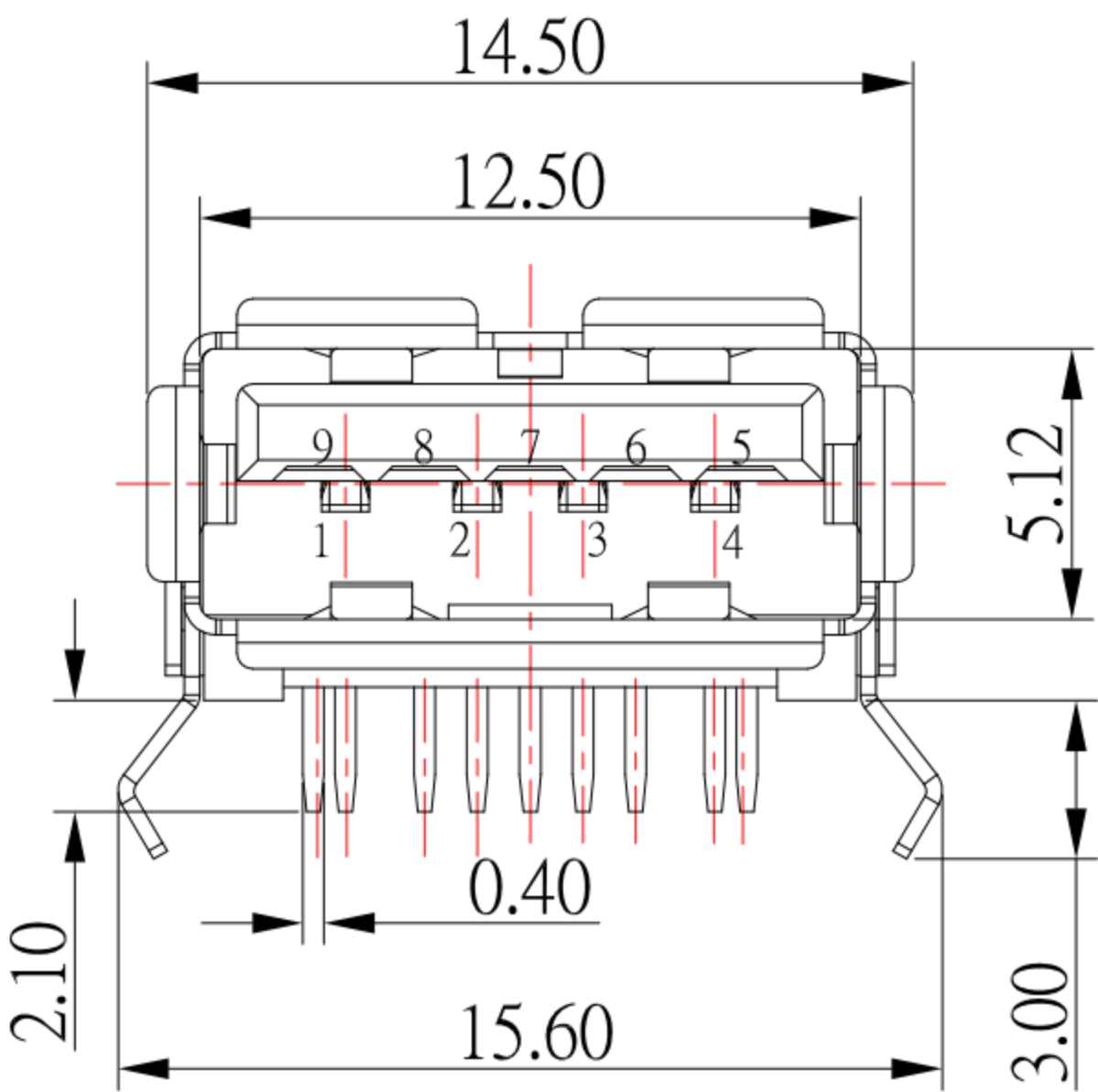
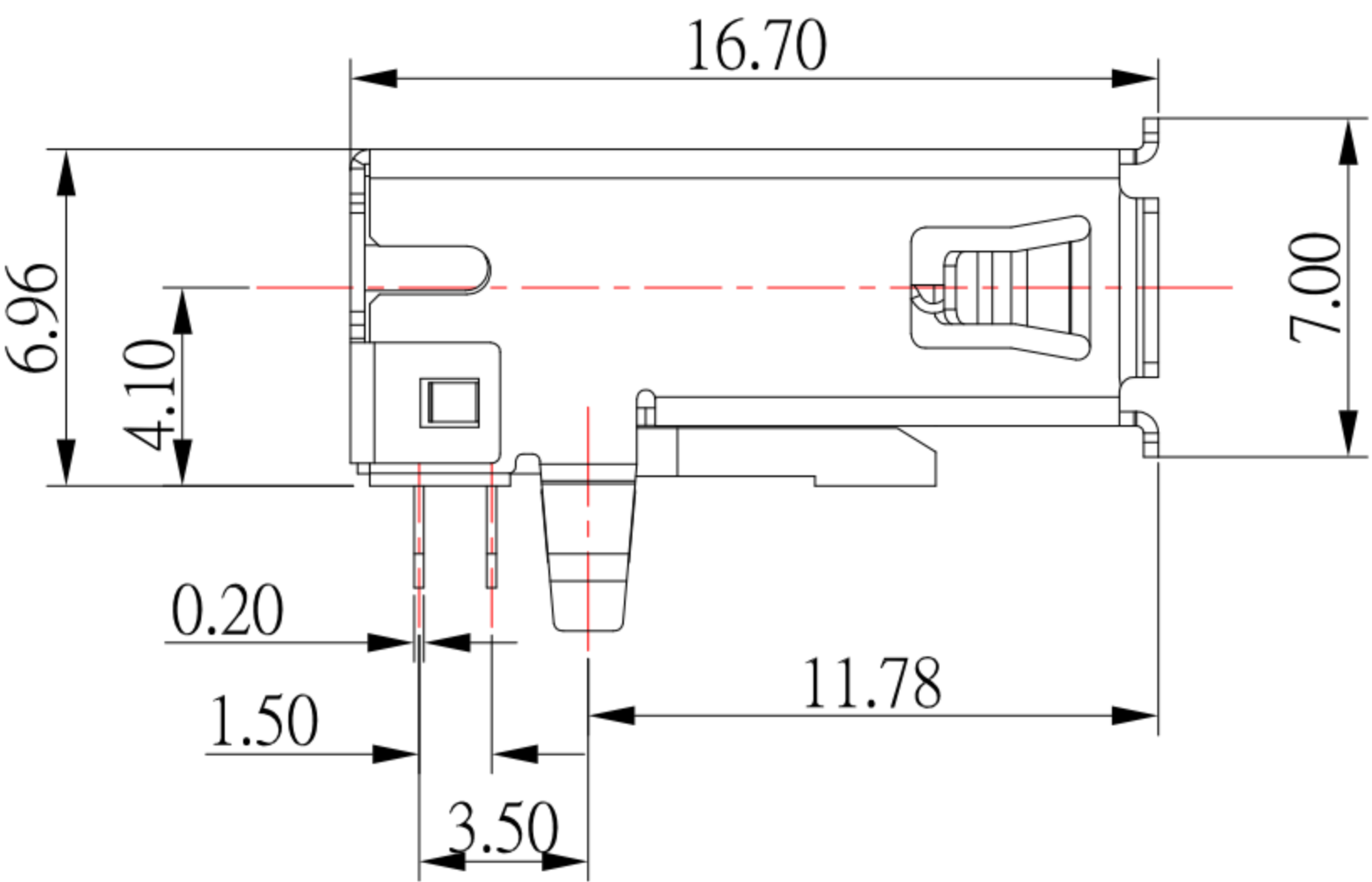
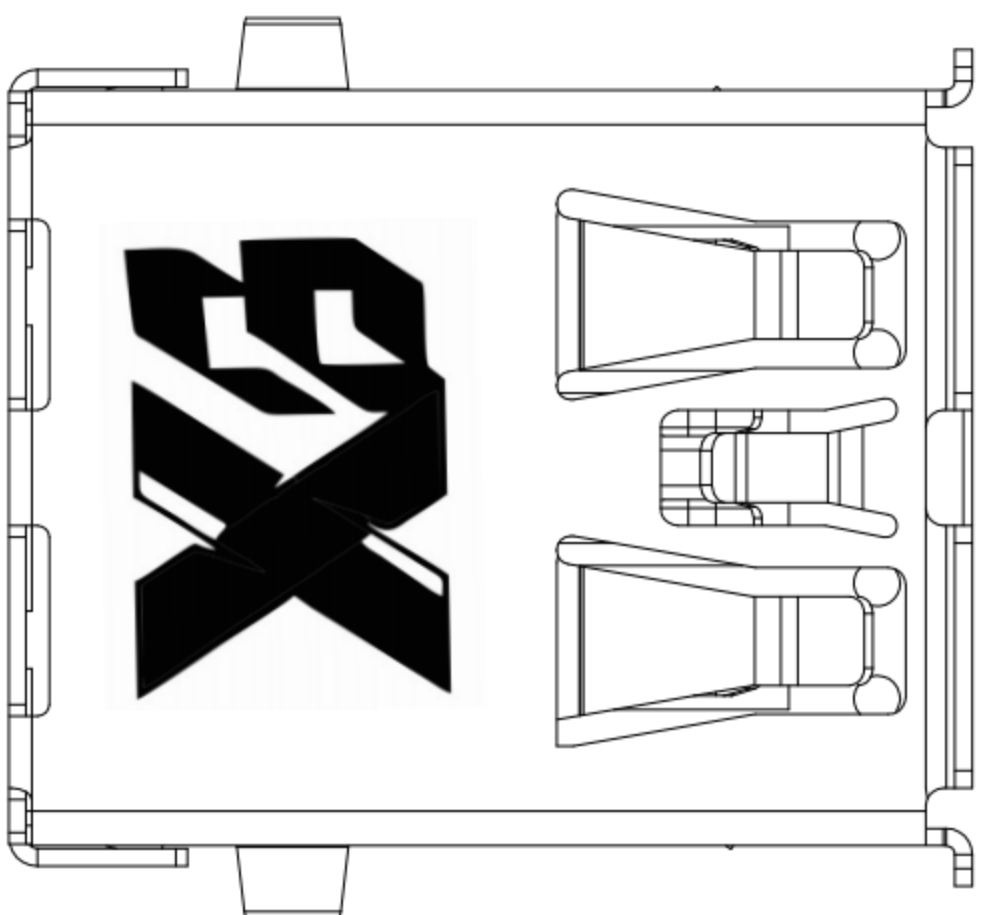




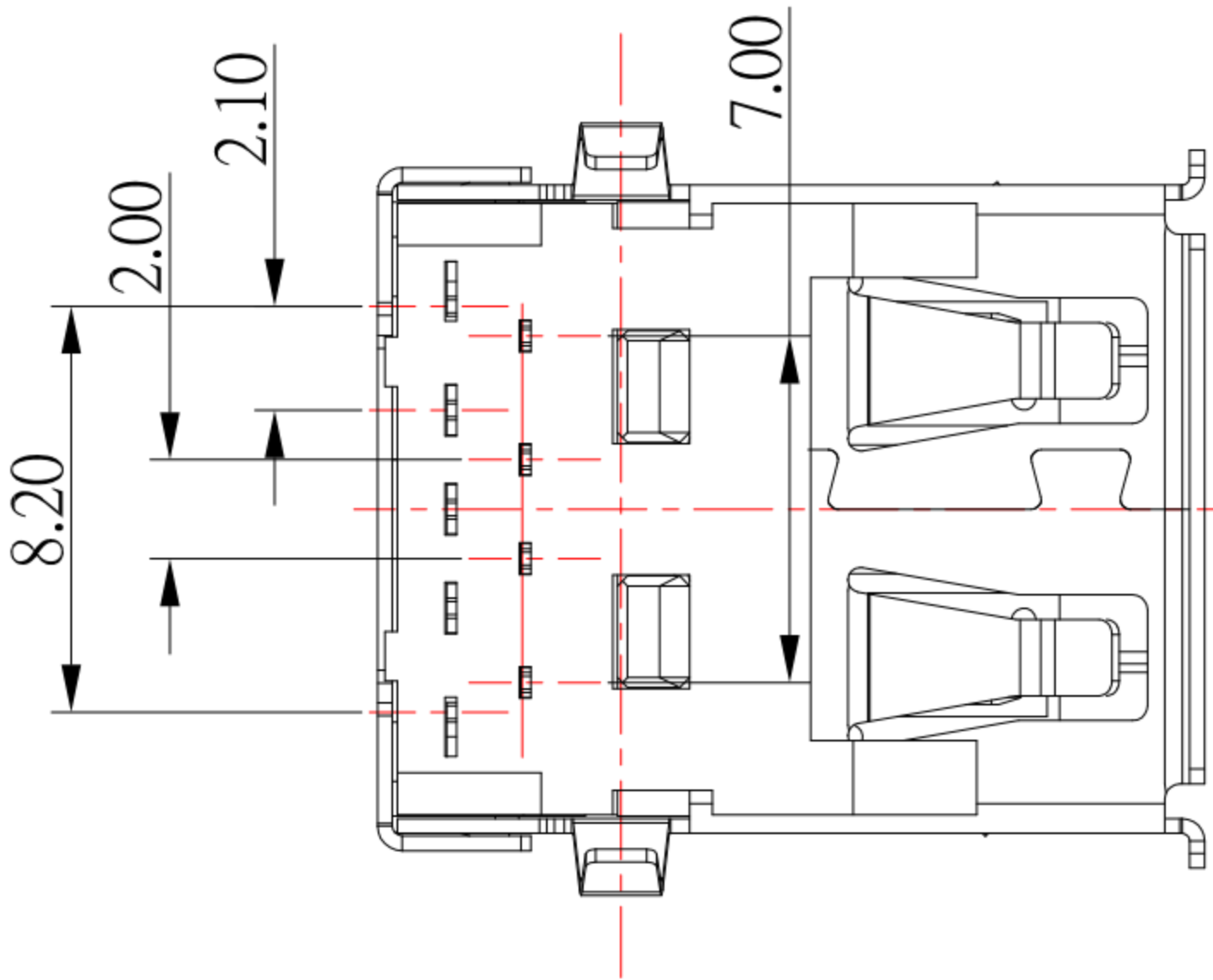
SUA-110H-30x-S277

鍍層厚度：

Blank : 1u"
2 : 15u"
3 : 30u"



RECOMMENDED PCBA LAYOUT



SPECIFICATIONS:

1.ELECTRICAL CHARACTERISTICS;

- 1.1 CONTACT CURRENT RATING: 1.5 A
- 1.1 CONTACT RESISTANCE: 30mΩ MAX
- 1.2 DIELECTRIC WITHSTANDING VOLTAGE: 100 V
- 1.3 INSULATION RESISTANCE: 100 MΩ MIN
- 1.4 OPERATING TEMPEROTURE: -40℃ ~ 85℃

2.MATERIAL:

- 2.1 HOUSING: PBT, UL 94V-0
- 2.2 CONTACT: PHOSPHOR BRONZE
- 2.3 SHELL: BRASS

3.PLATING:

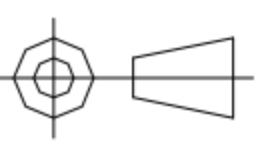
- 3.1 CONTACT: PLATED GOLD IN MATING AREA ;
TIN PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL
- 3.2 SHELL: NICKEL UNDER PLATED SURFACE LAYER



TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY:	DATE
Jack Lu	03/31/15
CHECKED BY:	DATE
Jacky Chen	03/31/15
APPROVED BY:	DATE
Tony Kao	03/31/15

MAT'L		TITLE	CONNECTOR
FINISH		MODLE	USB AF 3.0 90度DIP 彎腳
SCALE	1 : 1	DWG NO.	SUA-110H-30x-S277
SHEET NO.	1 of 1	PART NO.	SUA-110H-30x-S277
			SIZE A4
			VER R1